

Bostik MSP 200

PARQUET

Universal high performance parquet adhesive for all parquet types

PRODUCT USES

BOSTIK MSP 200 is a 1-Component MS polymer-based parquet adhesive suitable for securing all types of parquet floorings on absorbent and impervious substrates.

For direct bonding onto all types of substrates such as concrete screeds, cement/sand screeds, flooring grade plywood and particle board, metal decking, ceramic tiles, anhydrite screeds.

An adhesive with high suction grab for securing all types of wood onto all substrates:

- all wood species (including horn-beech, beech, birch and bamboo)
- Solid wood floor up to 200 mm width and 23 mm thickness
- unfinished or factory pre-finished parquet of any thickness and length
- mosaic parquet
- on-edge floorboards
- densified wood
- end-grain wood

Ideal for exotic timber.

PRODUCT BENEFITS

- Moisture-resistant (e.g. bonding teak in wet areas as bathrooms)
- No waiting time required
- Water-free, thus no damaging swelling effect on wood
- User-friendly: solvent- and isocyanate-free
- Environment-friendly: this product is classified A+ = Very Low Emission.
- Suitable for underfloor heating and cooling systems
- Permanently elastic at temperatures ranging from – 40° to +120°C
- High suction grab
- Adhesive residues on parquet flooring can be easily removed
- Restores its initial elasticity after compression or elongation
- Non-corrosive on metal decking
- Reduces significantly impact sound
- Package in 7kg pouch, very useful to install

TYPICAL PHYSICAL PROPERTIES

- Adhesive type: 1-component MS polymer-based adhesive
- Colour: light brown
- Specific gravity (NT T76.300): 1.60 ± 0.02
- Working time: 40 min. at 20°C depending on temperature, humidity and substrate absorbency
- Set to foot traffic: after 24 hours
- Definitively set to traffic: after 24 hours for domestic locations; 48 hours for high traffic areas
- Working temperature : Preferably between +10°C and +30°C. Material and substrate temperature not below +10°C.
- Pot life: 40 min. at 20°C
- Sanding and varnishing: after 48 to 72 hours

APPLICATION

PREPARATION

Preparation should be in accordance with building standards. Subfloors must be sound, even, smooth, permanently dry and free from old adhesive residues, dust, grease or other contaminants.

When overlaying existing floor coverings ensure that they are firmly bonded and clean.

Remove dirt, polish, oil and similar contaminating substances.

When further preparation of the subfloor is required, select suitable Bostik primers and Bostik smoothing and levelling compounds.

All surfaces must incorporate adequate damp proofing, if not, they should be primed with Eponal 336 Moisture

Vapour Barrier coating.
Always allow primers and self-levelling underlayment to dry thoroughly before applying the adhesive.

APPLICATION

Apply the adhesive evenly onto the substrate using a notched trowel Pajarito n069 or n°B11. No waiting time is necessary.

No primer is needed onto anhydrite screeds with BOSTIK MSP 200.

Place the wood flooring immediately in position and press firmly (or roll) over the whole surface to ensure good transfer.

Distorted floorboards need to be weighted and retained in position until full cure.

Using wedges, allow a gap of 8 mm between the parquet and walls. Remove the wedges immediately after installation. Gap dimensions: 0.15% of the largest dimensions of the area to be covered with flooring.

REMARKS

- Store the parquet in a dry place.
- Do not install parquet flooring if the relative humidity is over 65%.
- Underfloor heating systems must comply with current regulations. Turn off the heating 48 hours prior to installation. Wait for at least 1 week after laying the floor covering before gradually turning up the heating.
- MSP adhesive is very sticky, before starting any work we recommend to use protective gloves.
- Tightly close all containers after use.

Cleaning

Tools and fresh spillages should be cleaned with a methyl ethyl ketone (MEK) or acetone.

CONSUMPTION

700 to 1000 g/m²

SHELF LIFE

Up to 18 months in the original unopened container stored between +10°C and +30°C.

PACKAGING

Code	Packaging	Quantity	Bar Code
604783	7 kg Plastic bucket containing 1 pouch of 7 kg	1	3549212472467
604785	21 kg Plastic bucket containing 3 pouches of 7kg	1	3549212472481

SAFETY

IMPORTANT: before embarking on any work involving BOSTIK MSP 200 the separate Product Safety Data Sheet must be studied carefully by those carrying out the work.

Observe good hygiene in use. Avoid skin and eye contact.
For more details, consult the safety data sheet on www.quick-fds.com, or ask us a copy by fax.

Recommendations for implementation are defined through commonly used standards which should imperatively be respected (or followed). However, in case of first use or special characteristics related to the material support, the site or the environment, prior tests are advised (or are not exempted). It is recommended to follow our precautionary measures listed in the specification sheets.



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